



# BAS21QC-Q

## High-voltage switching diode

29 January 2025

Product data sheet

### 1. General description

High-voltage switching diode, encapsulated in an ultra small DFN1412D-3 (SOT8009, JEDEC MO340-CA) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

### 2. Features and benefits

- High switching speed:  $t_{rr} \leq 50$  ns
- Low leakage current
- High reverse voltage:  $V_R \leq 200$  V
- Low capacitance:  $C_d \leq 5$  pF
- Leadless ultra small SMD plastic package
- Low package height of 0.5 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Qualified according to AEC-Q101 and recommended for use in automotive applications

### 3. Applications

- High-speed switching
- General-purpose switching
- Voltage clamping
- Reverse polarity protection

### 4. Quick reference data

Table 1. Quick reference data

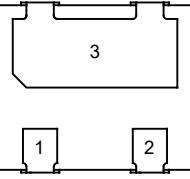
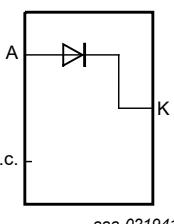
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_F$	forward current	$T_j = 25$ °C	[1]	-	-	250	mA
$V_R$	reverse voltage			-	-	200	V
$V_F$	forward voltage	$I_F = 200$ mA; $T_j = 25$ °C		-	-	1.25	V
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25$ °C		-	-	250	V
$I_R$	reverse current	$V_R = 200$ V; $T_j = 25$ °C		-	-	100	nA
$t_{rr}$	reverse recovery time	$I_F = 30$ mA; $I_R = 30$ mA; $R_L = 100$ Ω; $I_{R(meas)} = 3$ mA; $T_{amb} = 25$ °C		-	-	50	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70 µm copper, tin-plated and standard footprint.

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## 5. Pinning information

**Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 Transparent top view	 aaa-021941
2	n.c.	not connected		
3	K	cathode		

## 6. Ordering information

**Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
BAS21QC-Q	DFN1412D-3	plastic, leadless ultra small outline package with side-wettable flanks (SWF); 3 terminals; 0.8 mm pitch; 1.4 mm x 1.2 mm x 0.48 mm body	SOT8009

## 7. Marking

**Table 4. Marking codes**

Type number	Marking code
BAS21QC-Q	9Q

## 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134)*

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25^\circ\text{C}$		-	250	V
$V_R$	reverse voltage			-	200	V
$I_F$	forward current		[1]	-	250	mA
$I_{FSM}$	non-repetitive peak forward current	$t_p = 50 \mu\text{s}$ ; square wave; $T_{j(\text{init})} = 25^\circ\text{C}$		-	14.1	A
		$t_p = 10 \text{ ms}$ ; square wave; $T_{j(\text{init})} = 25^\circ\text{C}$		-	1.8	A
$I_{FRM}$	repetitive peak forward current	$t_p \leq 1 \text{ ms}$ ; $\delta \leq 0.25$		-	625	mA
$P_{\text{tot}}$	total power dissipation	$T_{\text{amb}} \leq 25^\circ\text{C}$	[1]	-	440	mW
			[2]	-	750	mW
$T_j$	junction temperature			-	150	°C
$T_{\text{amb}}$	ambient temperature			-55	150	°C
$T_{\text{stg}}$	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70  $\mu\text{m}$  copper, tin-plated and standard footprint.

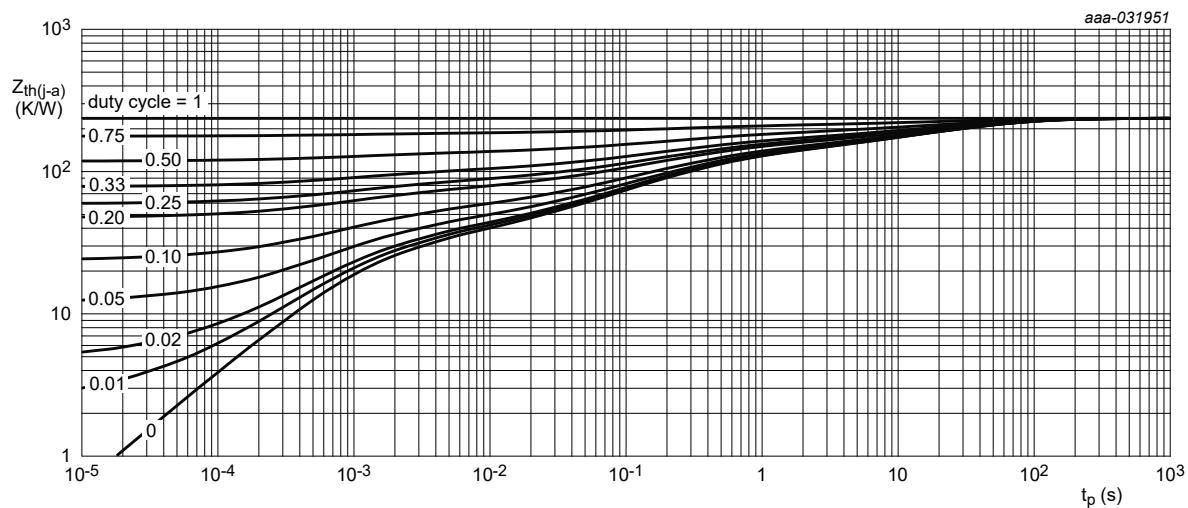
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70  $\mu\text{m}$  copper, tin-plated and mounting pad for cathode 1  $\text{cm}^2$ .

## 9. Thermal characteristics

Table 6. Thermal characteristics

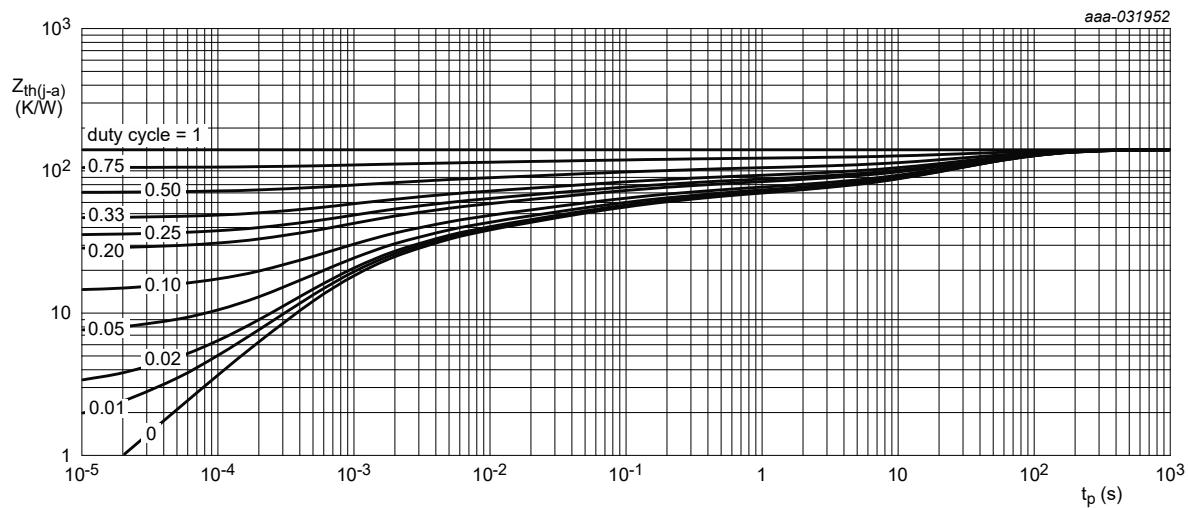
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	In free air	[1]	-	-	285	K/W
			[2]	-	-	160	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70  $\mu\text{m}$  copper, tin-plated and standard footprint.  
 [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70  $\mu\text{m}$  copper, tin-plated and mounting pad for cathode 1  $\text{cm}^2$ .



FR4 PCB, single-sided 70  $\mu\text{m}$  copper, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



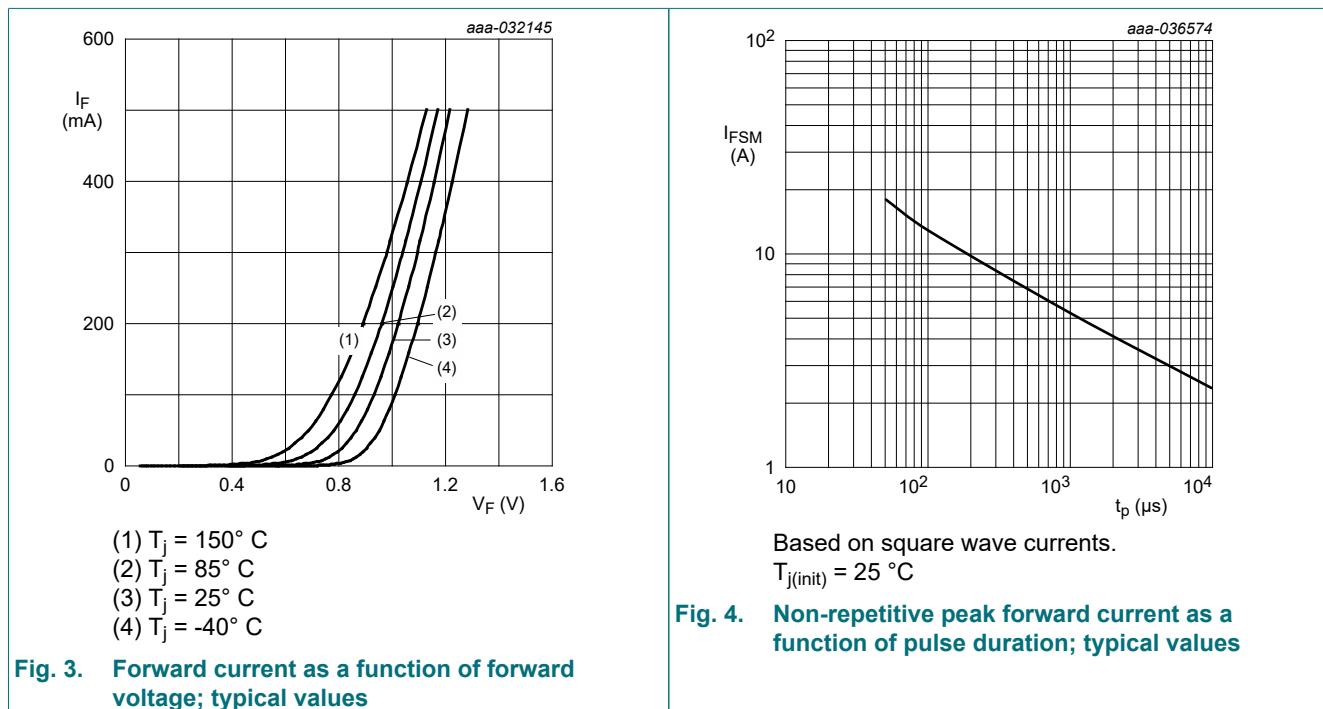
FR4 PCB, single-sided 70  $\mu\text{m}$  copper, 1  $\text{cm}^2$

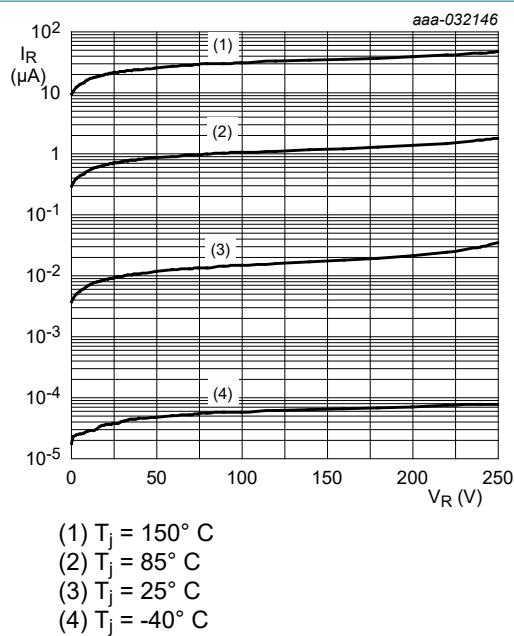
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

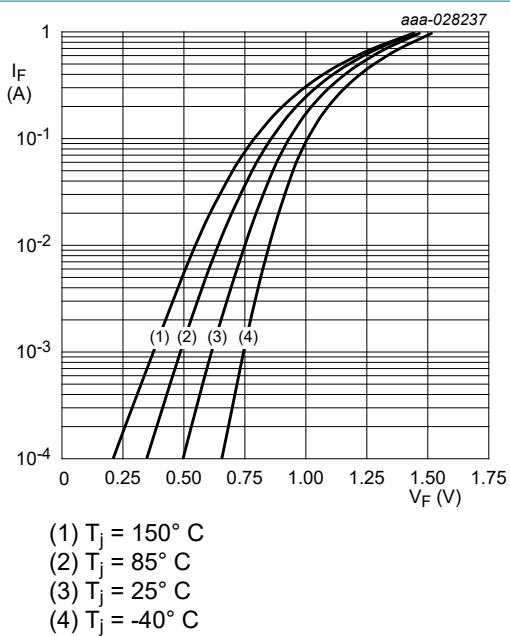
**Table 7. Characteristics**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_F$	forward voltage	$I_F = 100 \text{ mA}; T_j = 25^\circ \text{C}$	-	-	1	V
		$I_F = 200 \text{ mA}; T_j = 25^\circ \text{C}$	-	-	1.25	V
$I_R$	reverse current	$V_R = 200 \text{ V}; T_j = 25^\circ \text{C}$	-	-	100	nA
		$V_R = 200 \text{ V}; T_j = 150^\circ \text{C}$	-	-	100	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 0 \text{ V}; f = 1 \text{ MHz}; T_{\text{amb}} = 25^\circ \text{C}$	-	-	5	pF
$t_{rr}$	reverse recovery time	$I_F = 30 \text{ mA}; I_R = 30 \text{ mA}; R_L = 100 \Omega;$ $I_{R(\text{meas})} = 3 \text{ mA}; T_{\text{amb}} = 25^\circ \text{C}$	-	-	50	ns

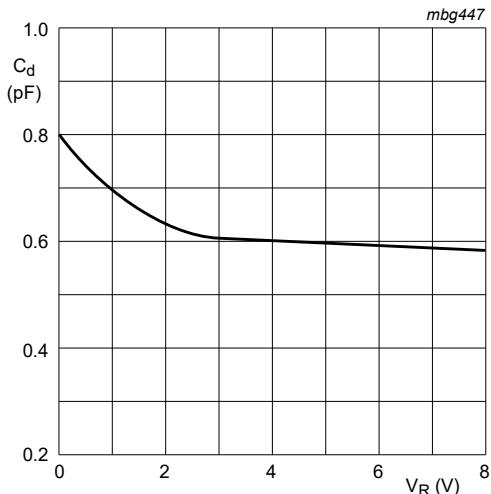




**Fig. 5. Reverse current as a function of reverse voltage; typical values**



**Fig. 6. Forward current as a function of forward voltage; typical values; (logarithmic scale)**



$f = 1$  MHz  
 $T_j = 25^\circ C$

**Fig. 7. Diode capacitance as a function of reverse voltage; typical values**

## 11. Test information

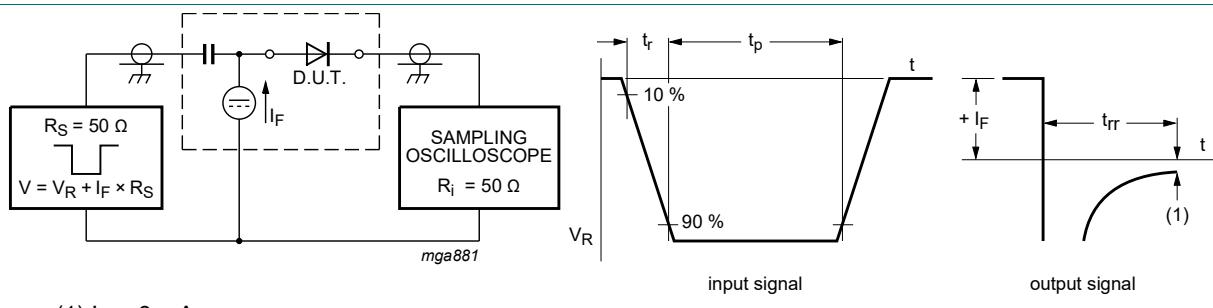


Fig. 8. Reverse recovery time test circuit and waveforms

## Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline

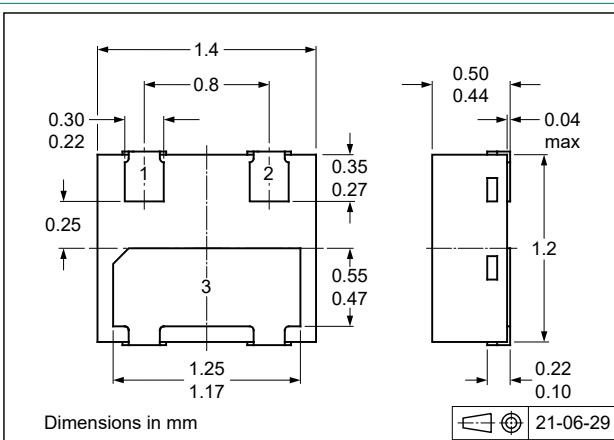
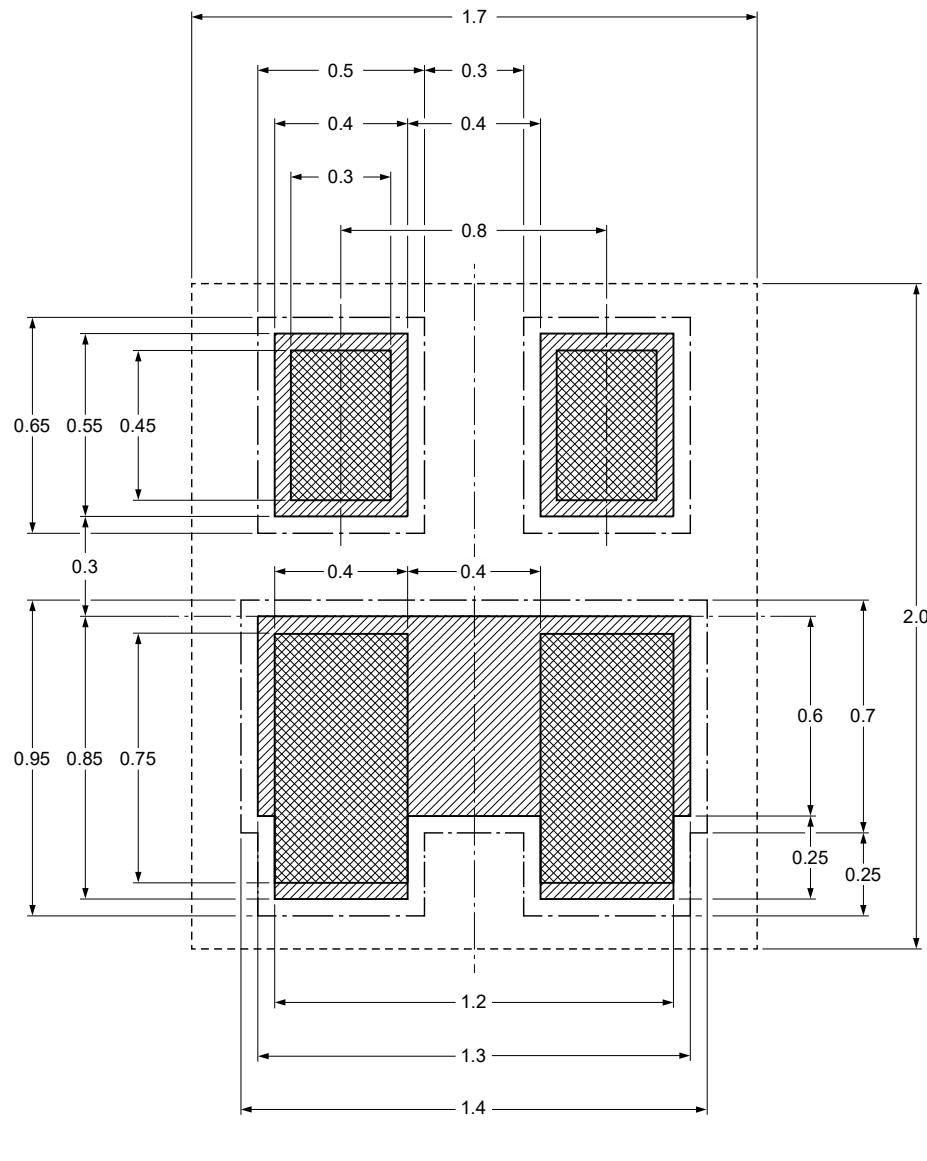


Fig. 9. Package outline DFN1412D-3 (SOT8009)

## 13. Soldering

Footprint information for reflow soldering of DFN1412D-3 package

SOT8009



[ ] occupied area

[ ] solder resist

[ ] solder land

[ ] solder paste

Dimensions in mm

Issue date 20-03-23

sot8009\_fr

Fig. 10. Reflow soldering footprint for DFN1412D-3 (SOT8009)

## 14. Revision history

**Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS21QC-Q v.3	20250129	Product data sheet	-	BAS21QC-Q v.2
Modifications:	<ul style="list-style-type: none"><li>Limiting values: <math>I_{F5M}</math> values changed</li><li>Characteristics: Fig. 4 added</li></ul>			
BAS21QC-Q v.2	20210504	Product data sheet	-	BAS21QC-Q v.1
BAS21QC-Q v.1	20210221	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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